

IGBT module with NCE Gen.7 Trench/  
Fieldstop IGBT and Emitter Controlled diode and PressFIT/NTC

**Features**

• Electrical features

Low  $V_{CEsat}$

$T_{vjop}=150^{\circ}C$

$V_{CEsat}$  with positive Temperature Coefficient

• Mechanical features

High Power and Thermal Cycling Capability

High Power Density

Isolated Base Plate

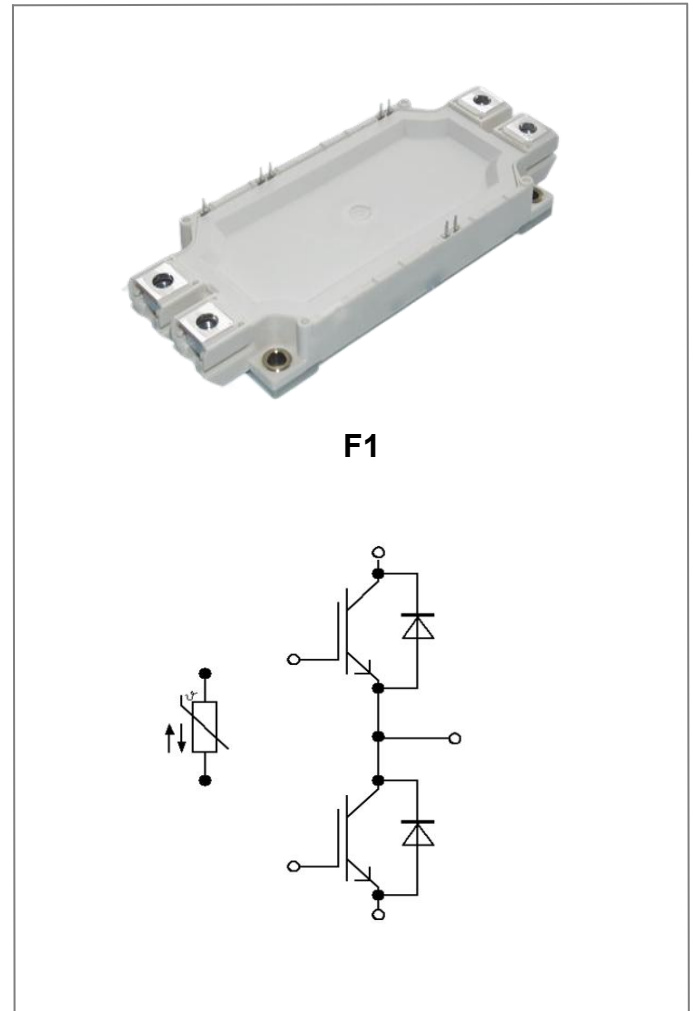
PressFIT Contact Technology

**Typical Applications**

- Construction, Commercial and Agriculture Vehicles
- High Power Converters
- Motor Drives
- Servo Drives

**Product validation**

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068



**Package Insulation coordination**

Symbol	Description	Note or test condition	Values	Unit
V <sub>ISOL</sub>	Isolation test voltage	RMS,f=50Hz,t=60s	2.5	kV
	Material of module baseplate		Cu	
	Internal isolation	basic insulation(class 1,IEC 61140)	Al <sub>2</sub> O <sub>3</sub>	
d <sub>creep</sub>	Creepage distance	terminal to heatsink	14.5	mm
d <sub>creep</sub>	Creepage distance	terminal to terminal	13.0	mm
d <sub>clear</sub>	Clearance	terminal to heatsink	12.5	mm
d <sub>clear</sub>	Clearance	terminal to terminal	10.0	mm
CTI	Comparative tracking index (electrical)		>200	

**Package Characteristic values**

Symbol	Description	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
M	Mounting torque for module mounting	-Mounting according to valid application note	M5, Screw	3.0	--	6.0	Nm
M	Terminal connection torque	-Mounting according to valid application note	M6, Screw	3.0	--	6.0	Nm
G	Weight			--	345	--	g

**Absolute Maximum Ratings  
IGBT**

Symbol	Description	Note or test condition	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	T <sub>vj</sub> = 25 °C	1200	V
I <sub>C nom</sub>	Continuous DC collector current	T <sub>C</sub> = 100 °C, T <sub>vj max</sub> = 175 °C	600	A
I <sub>C</sub>		T <sub>C</sub> = 25 °C, T <sub>vj max</sub> = 175 °C	950	A
I <sub>CRM</sub>	Repetitive peak collector current	t <sub>p</sub> = 1 ms	1200	A
P <sub>tot</sub>	Total power dissipation	T <sub>C</sub> = 25 °C, T <sub>vj max</sub> = 175 °C	2830	W
V <sub>GES</sub>	Gate-emitter peak voltage		±20	V

**Diode**

Symbol	Description	Note or test condition	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage	T <sub>vj</sub> = 25 °C	1200	V	
I <sub>F</sub>	Continuous DC forward current		600	A	
I <sub>FRM</sub>	Repetitive peak forward current	t <sub>p</sub> = 1 ms	1200	A	
I <sup>2</sup> t	I <sup>2</sup> t - value	t <sub>p</sub> = 10 ms, V <sub>R</sub> = 0 V	T <sub>vj</sub> = 125 °C	30200	A <sup>2</sup> s
			T <sub>vj</sub> = 150 °C	27700	

**IGBT Characteristics**

Symbol	Parameter	Note or Test Condition	Min	Typ	Max	Unit	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 600\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ }^\circ\text{C}$	--	1.55	1.80	V
			$T_{vj} = 125\text{ }^\circ\text{C}$	--	1.81	--	
			$T_{vj} = 150\text{ }^\circ\text{C}$	--	1.89	--	
$V_{GE(TH)}$	Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}, I_C = 12\text{ mA}, T_{vj} = 25\text{ }^\circ\text{C}$	5.6	6.2	6.8	V	
$I_{CES}$	Collector-Emitter Cutoff Current	$V_{GE} = 0\text{ V}, V_{CE} = 1200\text{ V}, T_{vj} = 25\text{ }^\circ\text{C}$	--	--	35	$\mu\text{A}$	
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}, T_{vj} = 25\text{ }^\circ\text{C}$	--	--	200	nA	
$R_{Gint}$	Internal Gate Resistance	$T_{vj} = 25\text{ }^\circ\text{C}$	--	1.34	--	$\Omega$	
$C_{ies}$	Input Capacitance	$f = 100\text{ KHz}, T_{vj} = 25\text{ }^\circ\text{C}, V_{CE} = 25\text{ V},$ $V_{GE} = 0\text{ V}$	--	96.34	--	nF	
$C_{res}$	Reverse Transfer Capacitance		--	0.48	--	nF	
$Q_G$	Gate Charge	$V_{GE} = 15\text{ V}, V_{CE} = 600\text{ V}$	--	3.32	--	$\mu\text{C}$	
$t_{d(on)}$	Turn-On Delay Time	$I_C = 600\text{ A},$ $V_{CE} = 600\text{ V},$ $V_{GE} = \pm 15\text{ V},$ $R_{Gon} = 2\text{ }^\circ\Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	--	0.39	--	$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	--	0.42	--	
			$T_{vj} = 150\text{ }^\circ\text{C}$	--	0.43	--	
$t_r$	Rise Time	$I_C = 600\text{ A},$ $V_{CE} = 600\text{ V},$ $V_{GE} = \pm 15\text{ V},$ $R_{Gon} = 2\text{ }^\circ\Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	--	0.09	--	$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	--	0.13	--	
			$T_{vj} = 150\text{ }^\circ\text{C}$	--	0.14	--	
$t_{d(off)}$	Turn-off Delay Time	$I_C = 600\text{ A},$ $V_{CE} = 600\text{ V},$ $V_{GE} = \pm 15\text{ V},$ $R_{Goff} = 2\text{ }^\circ\Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	--	0.54	--	$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	--	0.65	--	
			$T_{vj} = 150\text{ }^\circ\text{C}$	--	0.66	--	
$t_f$	Fall Time	$I_C = 600\text{ A},$ $V_{CE} = 600\text{ V},$ $V_{GE} = \pm 15\text{ V},$ $R_{Goff} = 0\text{ }^\circ\Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	--	0.08	--	$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	--	0.17	--	
			$T_{vj} = 150\text{ }^\circ\text{C}$	--	0.19	--	
$E_{on}$	Turn-On Switching Loss per Pulse	$I_C = 600\text{ A}, V_{CE} = 600\text{ V},$ $L_S = 50\text{ nH}, V_{GE} = \pm 15\text{ V},$ $R_{Gon} = 2\text{ }^\circ\Omega,$	$T_{vj} = 25\text{ }^\circ\text{C}$	--	39.06	--	mJ

		( $T_{vj\ max} = 175\ ^\circ\text{C}$ )	$T_{vj} = 125\ ^\circ\text{C}$	--	69.32	--	
			$T_{vj} = 150\ ^\circ\text{C}$	--	78.38	--	
$E_{off}$	Turn Off Switching Loss per Pulse	$I_C = 600\ \text{A}$ , $V_{CE} = 600\ \text{V}$ , $L_S = 50\ \text{nH}$ , $V_{GE} = \pm 15\ \text{V}$ , $R_{Goff} = 2\ \Omega$ , ( $T_{vj\ max} = 175\ ^\circ\text{C}$ )	$T_{vj} = 25\ ^\circ\text{C}$	--	52.71	--	mJ
			$T_{vj} = 125\ ^\circ\text{C}$	--	80.38	--	
			$T_{vj} = 150\ ^\circ\text{C}$	--	85.21	--	
$I_{sc}$	SC Data	$V_{GE} \leq 15\ \text{V}$ , $V_{CC} = 800\ \text{V}$ , $V_{CEmax} = V_{CES} - L_S \cdot di/dt$	$t_p \leq 10\ \mu\text{s}$ , $T_{vj} = 25\ ^\circ\text{C}$	--	2200	--	A
			$t_p \leq 10\ \mu\text{s}$ , $T_{vj} = 150\ ^\circ\text{C}$	--	2100	--	
$R_{thJC}$	Thermal resistance, junction to case	per IGBT		--	--	0.0531	K/W
$R_{thCH}$	Thermal resistance, case to heat sink	per IGBT $\lambda_{Paste} = 1\text{W}/(\text{m}\cdot\text{K})/\lambda_{grease} = 1\text{W}/(\text{m}\cdot\text{K})$		--	0.0217	--	K/W

### Diode Characteristics

Symbol	Parameter	Note or Test Condition	Min	Typ	Max	Unit	
$V_F$	Diode Forward Voltage	$I_F = 600\ \text{A}$ , $V_{GE} = 0\ \text{V}$	$T_{vj} = 25\ ^\circ\text{C}$	--	2.35	2.65	V
			$T_{vj} = 125\ ^\circ\text{C}$	--	2.30	--	
			$T_{vj} = 150\ ^\circ\text{C}$	--	2.25	--	
$Q_r$	Recovered Charge	$V_R = 600\ \text{V}$ , $I_F = 600\ \text{A}$ , $V_{GE} = -15\ \text{V}$ , $-di_F/dt = 3100\ \text{A}/\mu\text{s}$ ( $T_{vj\ max} = 175\ ^\circ\text{C}$ )	$T_{vj} = 25\ ^\circ\text{C}$	--	10.66	--	$\mu\text{C}$
			$T_{vj} = 125\ ^\circ\text{C}$	--	22.31	--	
			$T_{vj} = 150\ ^\circ\text{C}$	--	33.15	--	
$I_{RM}$	Peak Reverse Recovery Current	$V_R = 600\ \text{V}$ , $I_F = 600\ \text{A}$ , $V_{GE} = -15\ \text{V}$ , $-di_F/dt = 3100\ \text{A}/\mu\text{s}$ ( $T_{vj\ max} = 175\ ^\circ\text{C}$ )	$T_{vj} = 25\ ^\circ\text{C}$	--	139	--	A
			$T_{vj} = 125\ ^\circ\text{C}$	--	191	--	
			$T_{vj} = 150\ ^\circ\text{C}$	--	199	--	
$E_{rec}$	Reverse recovery energy	$V_R = 600\ \text{V}$ , $I_F = 600\ \text{A}$ , $V_{GE} = -15\ \text{V}$ , $-di_F/dt = 3100\ \text{A}/\mu\text{s}$ ( $T_{vj\ max} = 175\ ^\circ\text{C}$ )	$T_{vj} = 25\ ^\circ\text{C}$	--	9.85	--	mJ
			$T_{vj} = 125\ ^\circ\text{C}$	--	20.23	--	
			$T_{vj} = 150\ ^\circ\text{C}$	--	24.38	--	
$R_{thJC}$	Thermal resistance, junction to case	per diode		--	--	0.099	K/W
$R_{thCH}$	Thermal resistance, case to heat sink	per diode $\lambda_{Paste} = 1\text{W}/(\text{m}\cdot\text{K})/\lambda_{grease} = 1\text{W}/(\text{m}\cdot\text{K})$		--	0.021	--	K/W

**THERMAL PROPERTIES**

$T_{stg}$	Storage Temperature Range	-40 to 125	°C
$T_{vjop}$	Temperature under switching condition	-40 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**RECOMMENDED OPERATING RANGES**

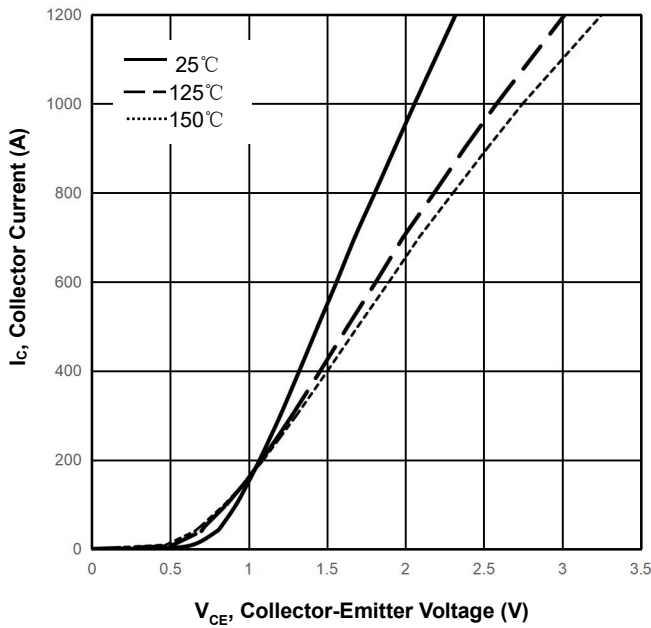
Symbol	Rating	Min	Max	Unit
$T_J$	Module Operating Junction Temperature	-40	175	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

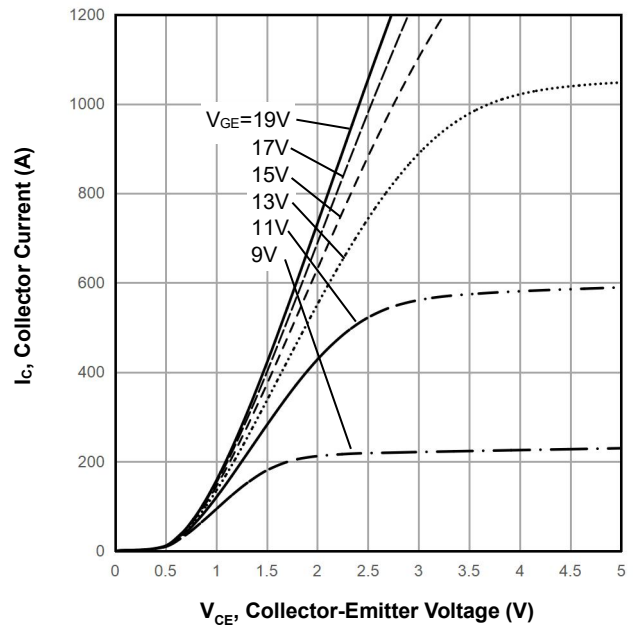
**NTC Characteristics**

Symbol	Parameter	Note or Test Condition	Value			Unit
			Min	Typ	Max	
$R_{25}$	Rated Resistance	$T_C = 25^\circ\text{C}$	--	5	--	k $\Omega$
$\Delta R/R$	Deviation of R100	$T_C=100^\circ\text{C}, R_{100}=493\Omega$	-5	--	5	%
$P_{25}$	Power Dissipation	$T_C = 25^\circ\text{C}$	--	--	20	mW
$B_{25/50}$	B-value	$R_2=R_{25} \exp[B_{25/50}(1/T_2 - 1/(298.15K))]$	--	3375	--	K
$B_{25/80}$	B-value	$R_2=R_{25} \exp[B_{25/80}(1/T_2 - 1/(298.15K))]$	--	3411	--	K
$B_{25/100}$	B-value	$R_2=R_{25} \exp[B_{25/100}(1/T_2 - 1/(298.15K))]$	--	3433	--	K

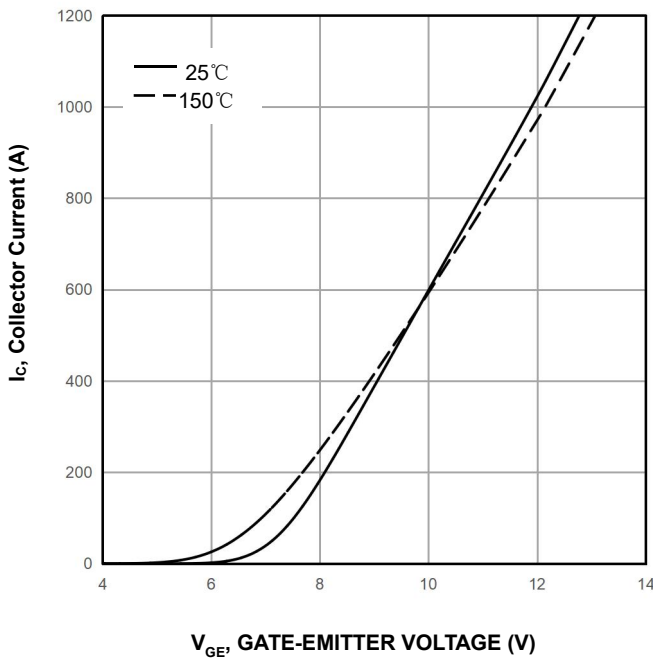
**Figure1. Output characteristic IGBT, Inverter (typical)**  
 $V_{GE} = 15V$



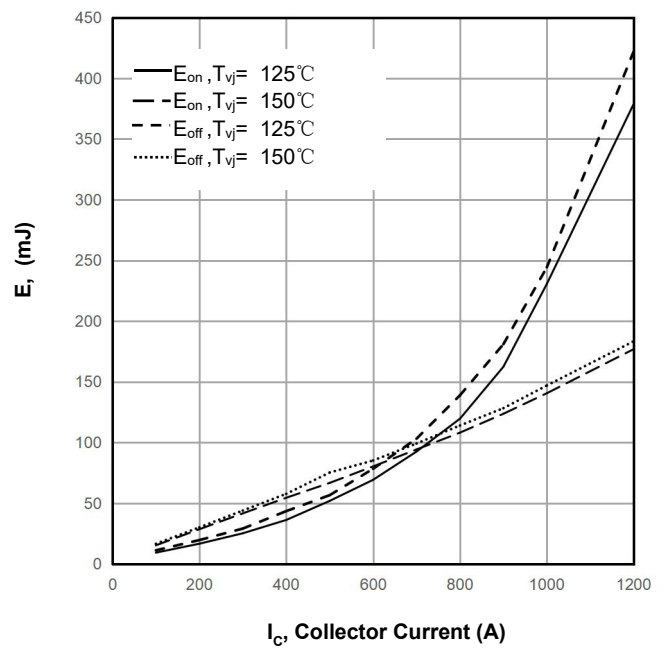
**Figure2. Output characteristic IGBT, Inverter (typical)**  
 $T_{vj} = 150^\circ C$



**Figure3. transfer characteristic IGBT, Inverter (typical)**  
 $V_{CE} = 60V$

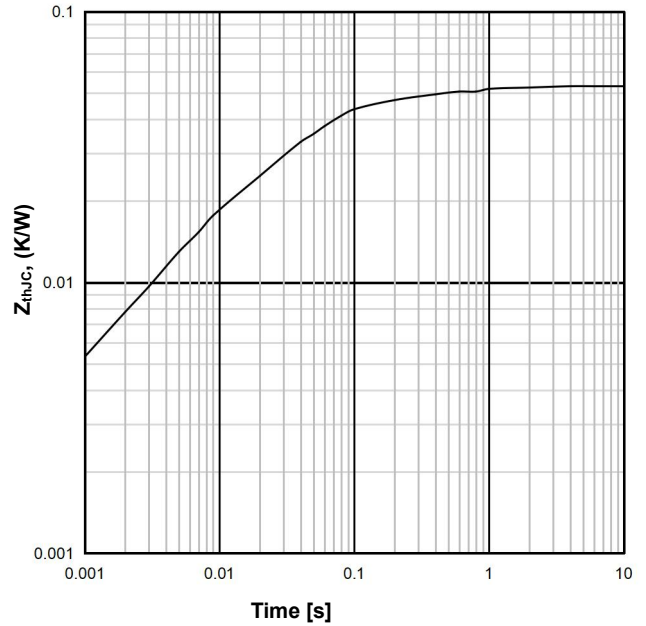
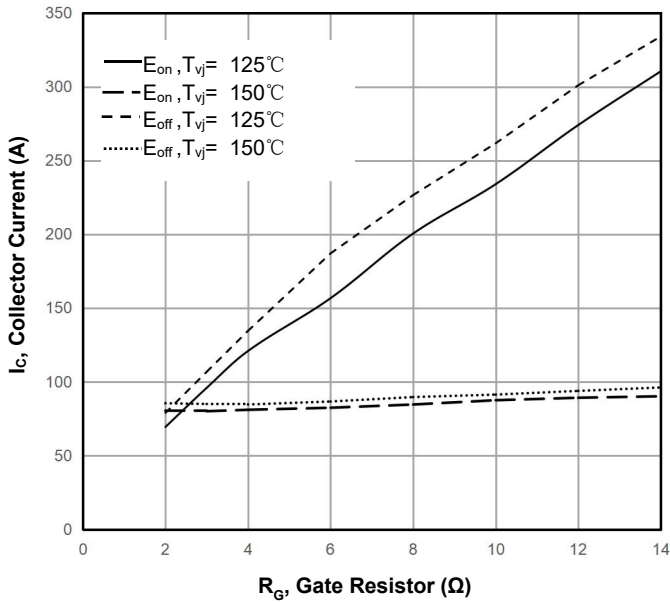


**Figure4. switching losses IGBT, Inverter (typical)**  
 $V_{CE} = 600V, V_{GE} = \pm 15V, R_G = 2\Omega$



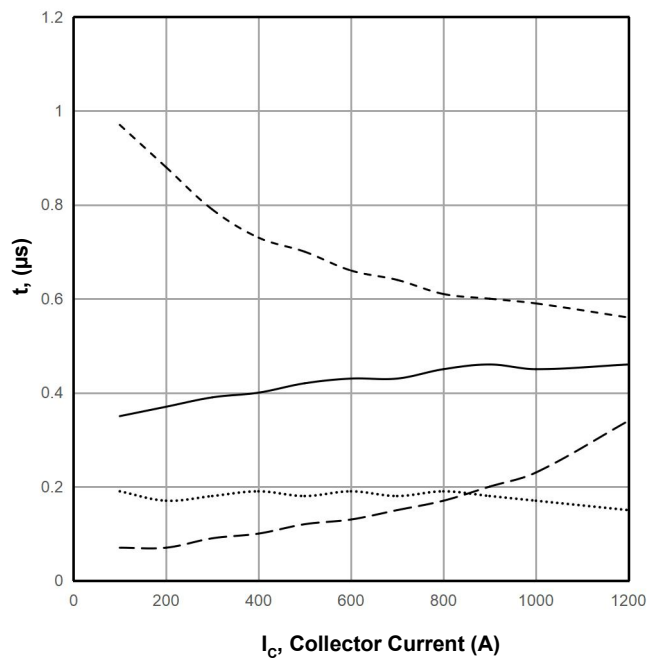
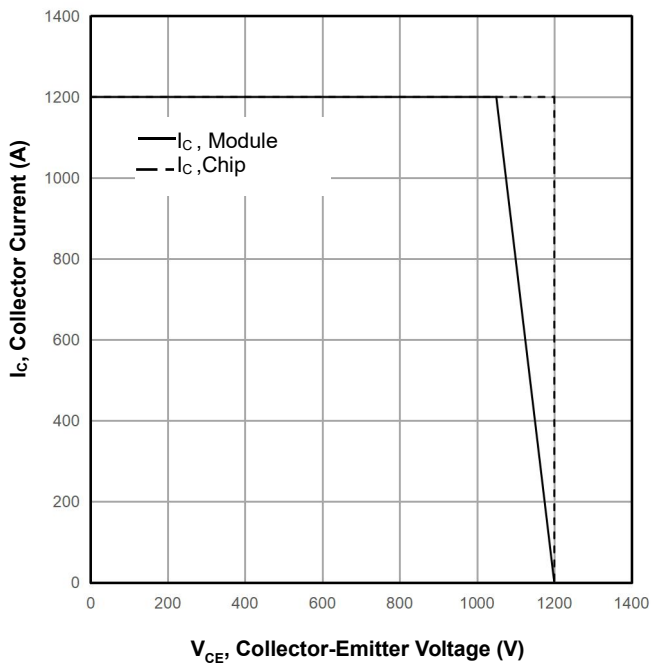
**Figure5. switching losses IGBT, Inverter (typical)**  
 $V_{CE}=600V, V_{GE}=\pm 15V, I_C=600A$

**Figure6. Transient thermal impedance IGBT, Inverter**



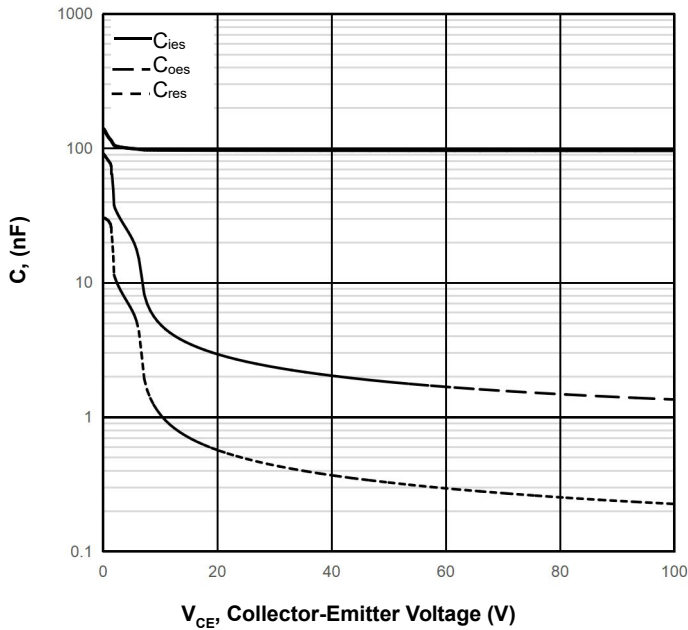
**Figure7. RBSOA IGBT, Inverter (typical)**  
 $V_{GE}=\pm 15V, R_{Goff}=2\Omega, T_{vj}=150^\circ C$

**Figure 8 .switching Time IGBT, Inverter (typical)**  
 $V_{CE}=600V, V_{GE}=\pm 15V, R_G=2\Omega, T_{vj}=150^\circ C$

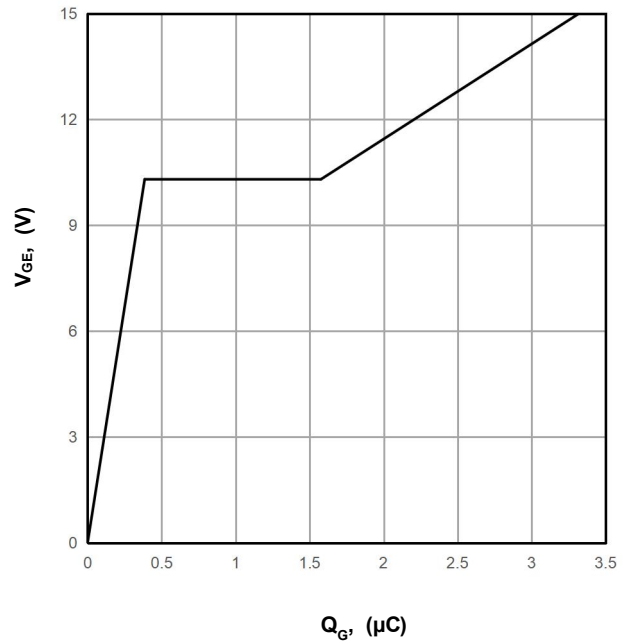




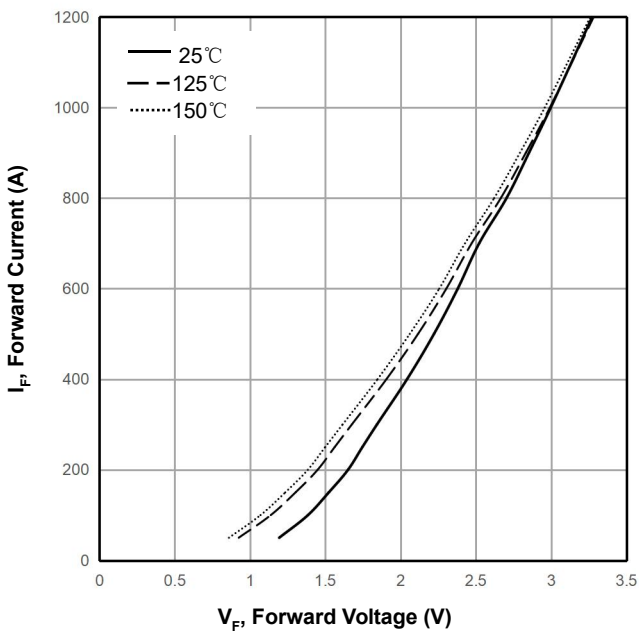
**Figure 9 .Capacitance IGBT,Inverter(typical)**  
 $f=100\text{KHz}, V_{GE}=0\text{V}, T_{vj}= 25^\circ\text{C}$



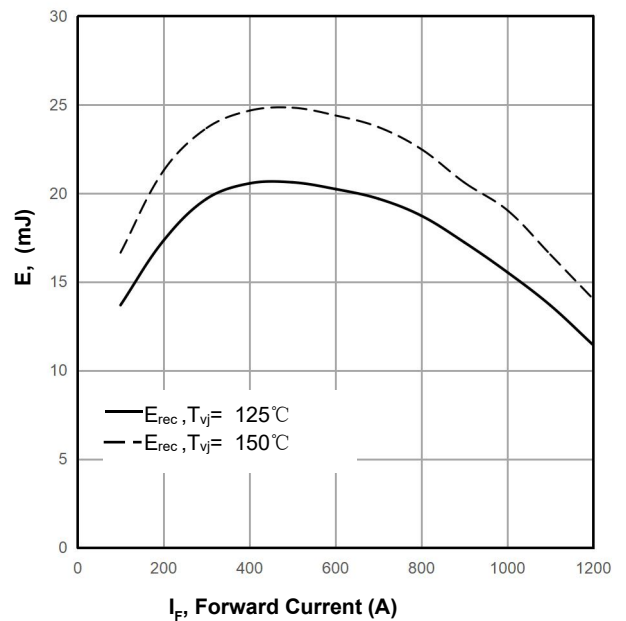
**Figure10.Gate Voltage(typical)**  
 $V_{CE}=600\text{V}, I_c=600\text{V}, T_{vj}= 25^\circ\text{C}$



**Figure 11.Forward Characteristic of Diode(typical)**

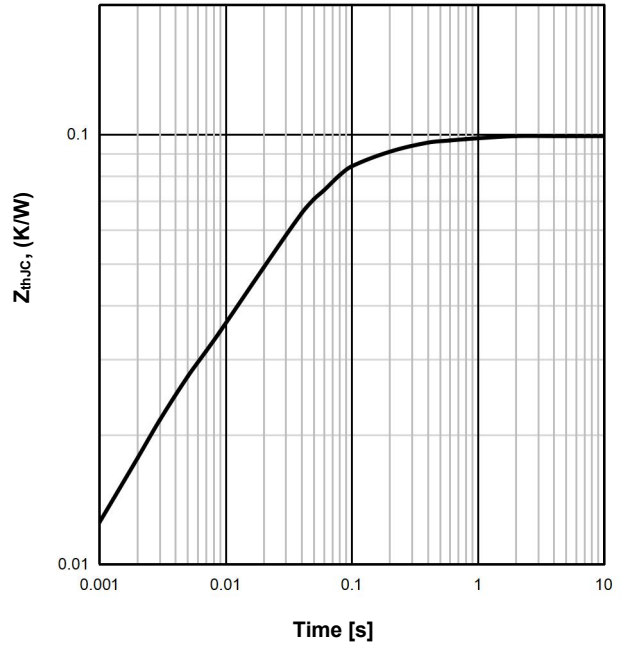
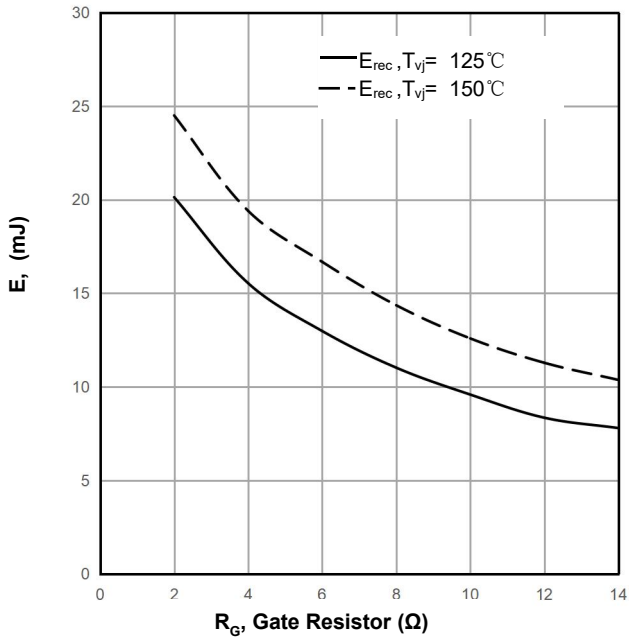


**Figure12.Switching losses Diode,Inverter(typical)**  
 $V_{CE}=600\text{V}, R_G=2\Omega$

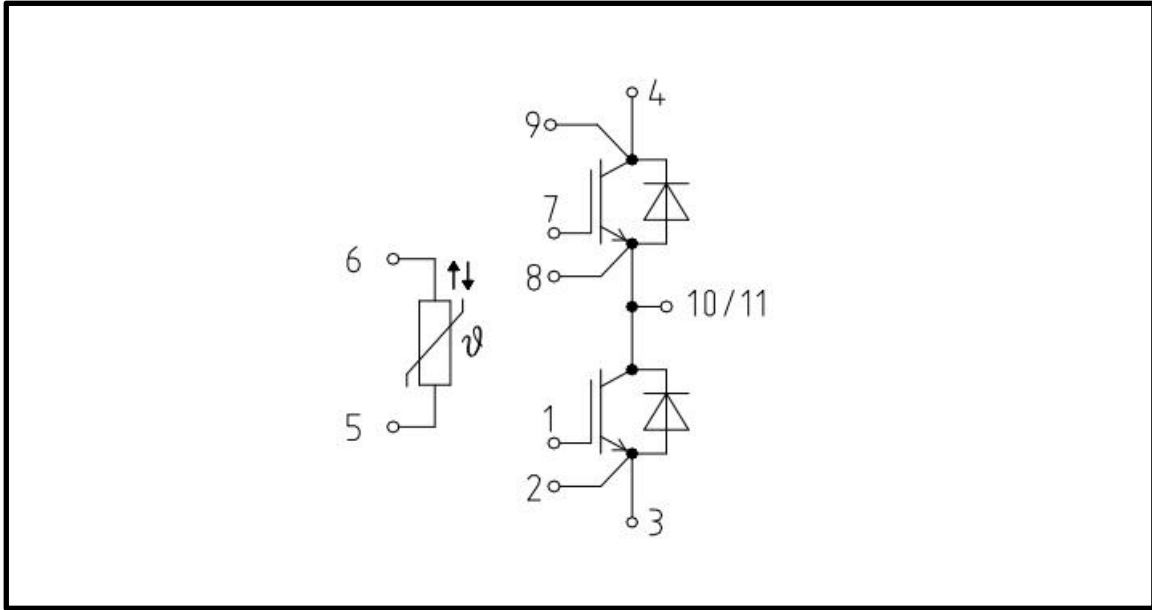


**Figure13. Switching losses Diode, Inverter (typical)**  
 $V_{CE}=600V, I_F=600A$

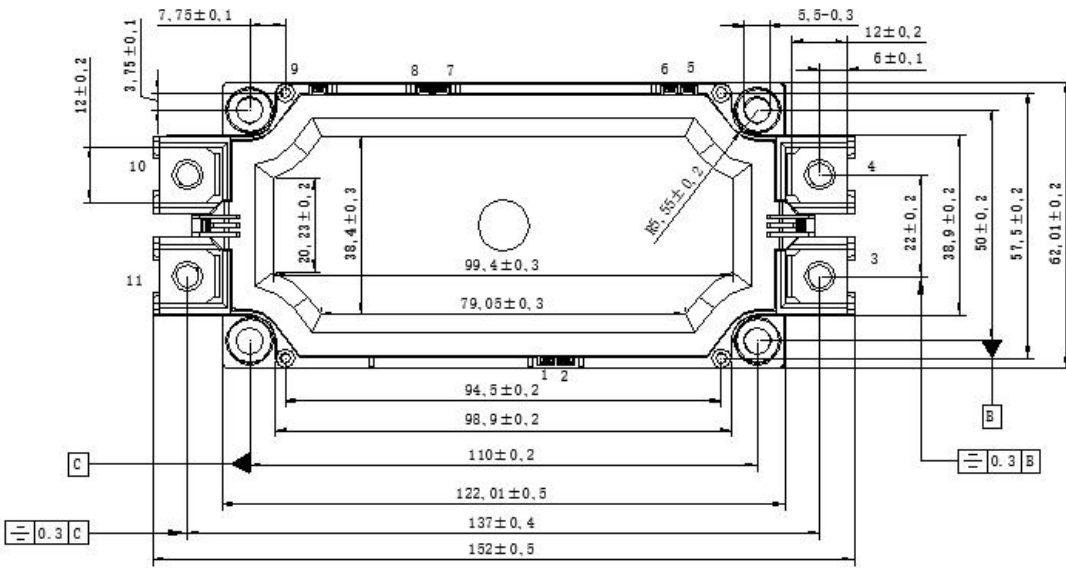
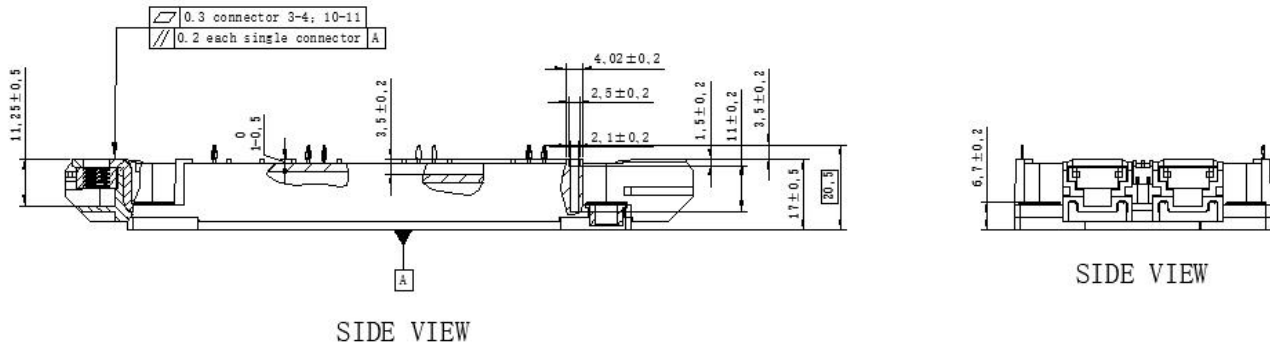
**Figure14. Transient thermal impedance Diode, Inverter**



**CIRCUIT DIAGRAM**



**PACKAGE DIMENSION**



**PCB孔位图**

